





Reduction of parasitic inductances (ESL) in capacitors

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Profile

- Fischer & Tausche was founded 1948 in Husum
- Family company
- Production and distribution of electrolytic- and metalized film capacitors
- Focus on individual developments and customized design
- Acquisition of Leclanché Capacitors (Switzerland) in 2004
- 2015 16 Mio Euro group sales
- 152 People in Husum + 20 people in Yverdon
- Exclusively manufacturing in Germany and Switzerland









Point of departure

- great progress in the development of IGBTs (SiC, GaN...)
- used in devices for the conversion and control of electrical energy
 - solar and wind power systems or for the power control of electric motors in e-cars
- trend toward increasingly higher switching frequencies

 \rightarrow DC link capacitors must have a very low inductive design!







Inductances

- <u>GENERAL RULE:</u>
 - Every current in a conductor creates a magnetic field
 - Current changes over time induce voltages
 - The larger the area surrounded by a current loop, the larger is the magnetic field. This means that all electrical wires must be kept as short as possible.
 - If current carrying back and forth conductors are close together, their magnetic fields will partially cancel each other
 - Parallel-connected inductances reduce the overall inductance.















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Self Inductance

U = L dl/dt

Relationship between U, L and I(t







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Effect of parasitic inductances

- Ideal capacitor: the reactance is proportionally inverse to the frequency→ as the frequency increases, the reactance of the capacitor decreases, and with constant AC voltage the current increases accordingly
- <u>real capacitor</u>: only approximately true and applicable only to the lower frequency range
- ideal vs. real capacitor: ohmic losses (ESR) and the parasitic inductance (ESL) of the capacitor must also be considered!









XL

ESR

Effect of parasitic inductances

ESR

 Origin of the thermal losses in the capacitor and consists of the sum of the ohmic resistances and the frequency-dependent dielectric losses

ESL

- sum of all inductive parts of the capacitor
- reactance, however with a negative sign and an inverse gradient than the capacitive reactance
- together with the ESL, the capacitance of the capacitor forms a







Situation of L related to terminals/connectors of capacitors









Situation of L in the capacitor winding



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Effect of parasitic inductances

- through the vectorial addition of the two reactances and the ESR, dependent on the frequency, it is possible to determine the impedance of the capacitor
- Figure: typical V-shaped behaviour, which at its lowest point touches the ESR curve. This is the resonant point where the reactances of the capacitance and the inductance cancel each other out
- above the resonant frequency the impedance of the capacitor is dominated by the inductive components









Effect of parasitic inductances

Summary:

- In order to use the capacitive properties of the capacitor for a wide range of frequencies, it is necessary to shift the resonant frequency as far as possible! to higher frequency values
- At a given capacitance, this can be achieved only through consistent reduction of the parasitic inductances!







FTCAP offers innovative solutions

for these problems!







Coax Cap

- capacitor winding that is completely enclosed in copper
- milled bottom surface
- extremely low inductance construction (<10nH)
- optimal thermal characteristics
- high current-carrying capacity, with no limitation of the selfhealing properties









Energy Cap

- designed for frequency converters, DC filters and DC links
- connections between terminals and the far side of the most distant capacitor winding as short as possible → low inductance!
- possible to achieve inductances between 40 nH and 100 nH









Copper capacitors

- low inductance alternative to DC link capacitors in combination with fast IGBTs
- solid, enclosed copper construction and the intelligent selection of materials allows inductances below 10 nH
- thermally optimised design ensures a long life
- capacitor is isolated and therefore potential free









FischerLink

- Iow inductance solution from FTCAP
- capacitors are welded directly to the adjacent low inductance copper plates of the internal bus-bar (=without having their own terminals → shortening the connecting wires)
- possible to achieve an ESL of less than 20 nH even in the case of large models









Low inductance electrolytic capacitors

- possible to construct single aluminium electrolytic capacitors for DC link applications with extremely low inductance
- FTCAP uses patented short connection bands to achieve the extremely low values
- Many standard types also available as special low inductance versions









New IGBT connection terminal

- technical innovation: we can now also offer low inductance IGBT terminals
- new patent-pending
 connection lugs enable
 unprecedented low
 inductance connection of the
 DC link capacitor to the
 switching transistors











Inversely directed magnetic fields attenuate one another







Thank you very much for your attention!

Speaker: Dr. Thomas Ebel

<u>FTCAP GmbH</u> Carl-Benz-Straße 1 D-25813 Husum Germany

Elincom Electronics Klaverbaan 101 2908 KD Capelle aan den Ijssel 010- 26 40 270